

APPLICATIONS MUST BE RECEIVED BY MAY 31, 2023.

MUST BE LEGIBLE - IF WE CAN'T READ IT YOU WILL BE DISQUALIFIED

The Hawaii Wall & Ceiling Industry Association Scholarship Fund

The Hawaii Wall & Ceiling Industry Association Scholarship Fund was established in 2003 to provide educational assistance to members of the HWCIA and/or their dependents who are entering either a two or four-year college.

APPLICATION DEADLINE: Applications must be received by May 31st of each year. Scholarship recipients will be selected in June and funds disbursed in July.

Eligibility Criteria:

- 1) Applicant must be a member, or dependent of a member, of the Hawaii Wall & Ceiling Industry Association as well as a member of the Carpenter's, Taper's or Plasterers Unions.
- 2) Member must be in good standing with the association, trust funds and the unions.
- 3) If selected, proof of registration at a qualified educational institute must be presented.
- 4) **Applicant must be enrolled in an accredited college or university as a full time student taking a minimum of 12 credit hours and must maintain a minimum GPA of 2.0.**

Selection Criteria:

- 1) Scholastic Achievement – Most recent transcript must accompany application. A GPA of no less than 2.0 is required
- 2) Leadership and/or Community Service – Participation in Extracurricular activities in school such as sports, student government and school sponsored organizations. Participation in community service projects.
- 3) A one-page essay describing your future goals.
- 4) Two letters of recommendation – one from a teacher or counselor and another from an employer, minister or community leader who is not related to you.

Instructions:

Completed application form must be legible, in pdf format and submitted with the required documents and letters by May 31, 2023. If you have any questions you may call (808) 839-6517. Email to bbakono@aol.com or mail to HWCIA, 3375 Koapaka St. #D131, Honolulu, Hawaii 96819.

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DISQUALIFIED PLEASE SUBMIT IN PDF FORMAT

Send to:
HWCIA
3375 Koapaka St. Suite
D131 Honolulu, Hawaii
96819
Or email to bbakono@aol.com

Applicant's Full Name: _____ **Date of Birth:** _____

Address: _____ **City,** _____ **State**

_____ **Zip** _____

E-mail: _____ **Phone:** _____

School Presently Attending: _____

Your current Grade Level: _____

Father's Name (or Guardian's name): _____

Father's Employer: _____ **Union Affiliated with:** _____

Mother's Name (or Guardian's Name): _____

Mother's Employer: _____ **Union Affiliated with:** _____

What field of study do you plan to pursue? _____

What school do you plan on attending? _____

Have you been accepted at this institution? _____

What extracurricular or community activities do you participate in?

Have you received any Awards, Honors or Special Recognition from your school or for community service?
